# **Power MOSFET** 30V, 7 mΩ, 89A, Single N–Channel SO8FL

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS4841NWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Paran	Symbol	Value	Unit		
Drain-to-Source Voltage			V <sub>DSS</sub>	30	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain Cur-		$T_{mb} = 25^{\circ}C$	۱ <sub>D</sub>	89	А
rent R $_{\Psi J-mb}$ (Notes 1, 2, 3, 4)	Steady State	$T_{mb} = 100^{\circ}C$		63	
Power Dissipation		$T_{mb} = 25^{\circ}C$	PD	112	W
$R_{\Psi J-mb}$ (Notes 1, 2, 3)		$T_{mb} = 100^{\circ}C$	l	56	
Continuous Drain Cur-		$T_A = 25^{\circ}C$	۱ <sub>D</sub>	16	А
rent R <sub>θJA</sub> (Notes 1 & 3, 4)	Steady State	T <sub>A</sub> = 100°C		11	
Power Dissipation		T <sub>A</sub> = 25°C	PD	3.7	W
R <sub>θJA</sub> (Notes 1, 3)		T <sub>A</sub> = 100°C		1.8	
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	336	А
Current limited by package $T_A = 25^{\circ}C$ (Note 4)			I <sub>DmaxPkg</sub>	80	А
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C
Source Current (Body Diode)			۱ <sub>S</sub>	51	А
Single Pulse Drain-to-Source Avalanche Energy (T <sub>J</sub> = 25°C, V <sub>DD</sub> = 24 V, V <sub>GS</sub> = 10 V, $I_{L(pk)}$ = 19 A, L = 1.0 mH, R <sub>G</sub> = 25 $\Omega$ )			E <sub>AS</sub>	180	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

	-	-	
Parameter	Symbol	Value	Unit
Junction-to-Mounting Board (top) - Steady State (Note 2, 3)	$R_{\Psi J-mb}$	1.3	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

 Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.
Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

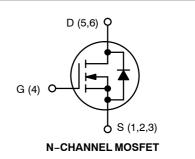
 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

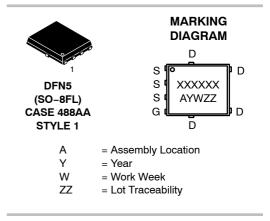


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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
30 V	7.0 m $\Omega$ @ 10 V	
	11.4 mΩ @ 4.5 V	89 A





#### **ORDERING INFORMATION**

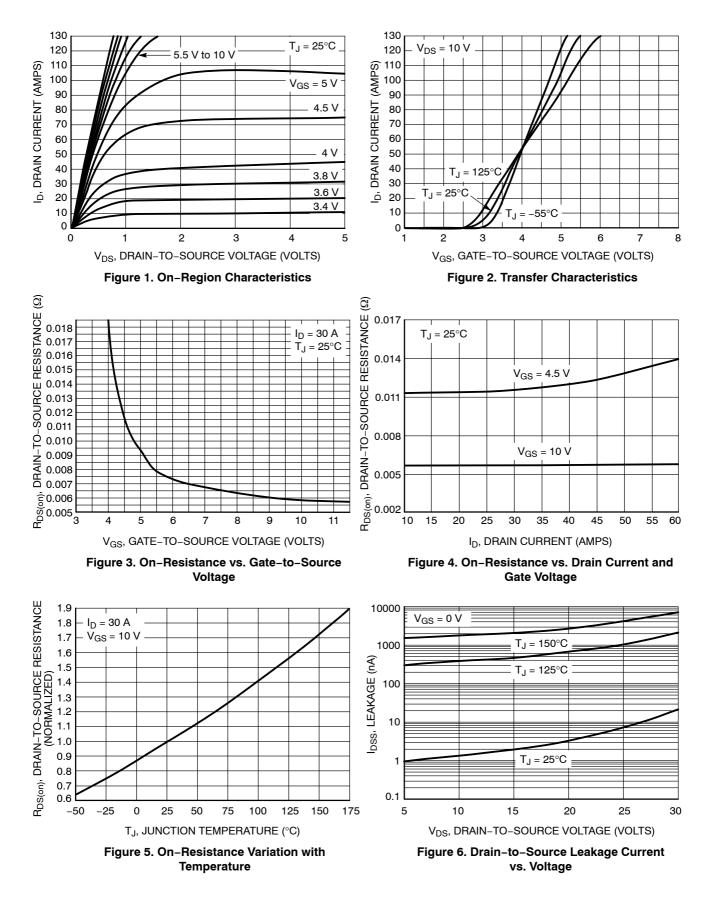
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

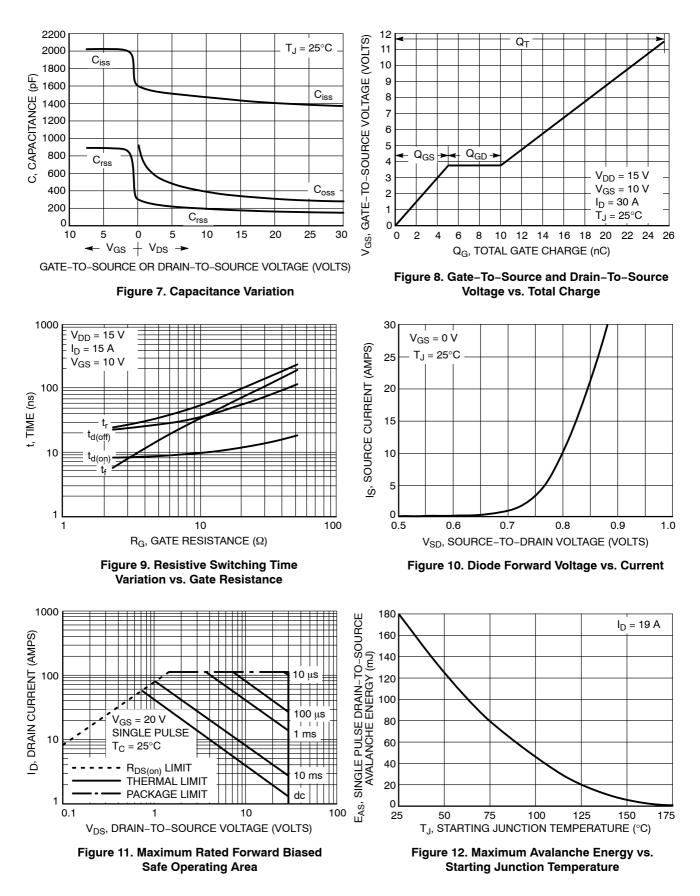
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-	-		-	-	-	-
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				25		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25 °C			1	μΑ
		$V_{\rm DS} = 30$ V	T <sub>J</sub> = 125°C			10	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub>	<sub>S</sub> = ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		1.5		2.5	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				5.6		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A		4.7	7.0	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 30 A		9.2	11.4	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A			16		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 12 V			1436		pF
Output Capacitance	C <sub>OSS</sub>				348		
Reverse Transfer Capacitance	C <sub>RSS</sub>				177		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			11.5	17	nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				2.0		
Gate-to-Source Charge	Q <sub>GS</sub>				5.0		
Gate-to-Drain Charge	Q <sub>GD</sub>				5.1		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 15 V, $I_{D}$ = 30 A			25.4		nC
SWITCHING CHARACTERISTICS (Note 6)							
Turn-On Delay Time	t <sub>d(ON)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A, R <sub>G</sub> = 3.0 Ω			13.5		- ns
Rise Time	t <sub>r</sub>				66.5		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				15.5		
Fall Time	t <sub>f</sub>				7.5		
DRAIN-SOURCE DIODE CHARACTERISTIC	S						
Forward Diode Voltage	V <sub>SD</sub>	$V_{CS} = 0 V_{c}$	$T_J = 25^{\circ}C$		0.9	1.2	v
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 30 A	T <sub>J</sub> = 125°C		0.8		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 30 A			20.5		ns
Charge Time	t <sub>a</sub>				11.6		
Discharge Time	t <sub>b</sub>				8.9		
Reverse Recovery Charge	Q <sub>RR</sub>				10.7		nC

 $\begin{array}{ll} \text{5. Pulse Test: pulse width} \leq 300 \ \mu\text{s} \text{, duty cycle} \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$ 

#### **TYPICAL PERFORMANCE CURVES**



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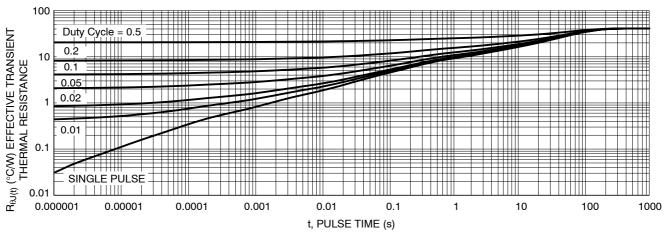


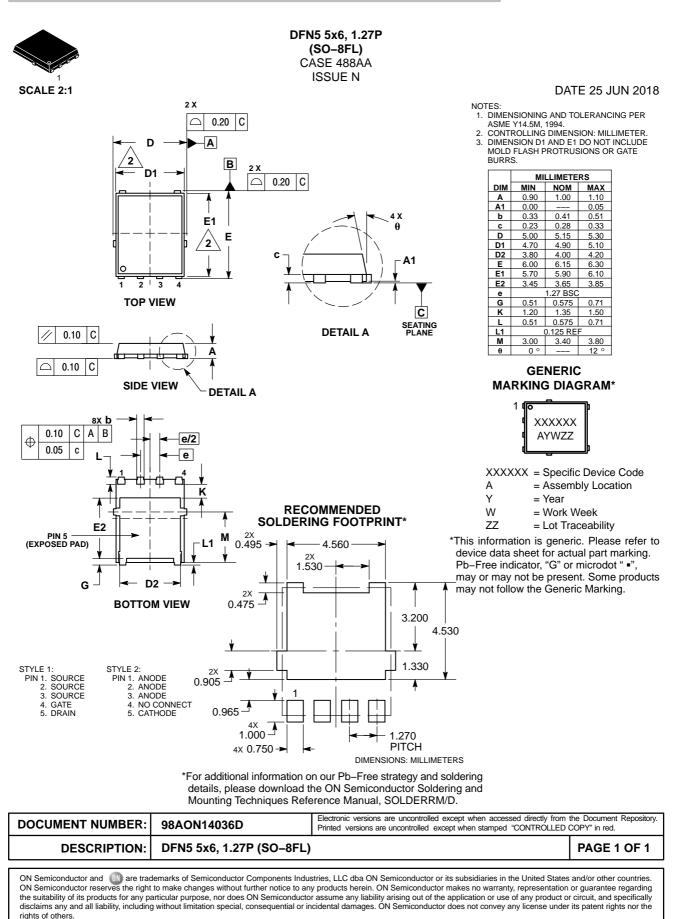
Figure 13. FET Thermal Response

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NVMFS4841NT1G	V4841	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS4841NWFT1G	4841WF	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS4841NT3G	V4841	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS4841NWFT3G	4841WF	DFN5 (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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